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FORM PTO-1595 1/31/92	EET	U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks: Please Record the attached original documents or copy thereof.

1. Name of conveying party(ies):

SHUSAKU YANAGAWA
MASATSUGU IKEDA
KENICHI KUBO
YOUICHI GOTO

6/4/02

Additional name(s) of conveying party(ies) attached?
☐ Yes ☒ No

2. Name and address of receiving party(ies):
Name: Sony Corporation

Internal Address:
7-35, Kitashinagawa 6-chome
Shinagawa-ku, Tokyo 141, Japan

Street Address:

City: State: Zip:

Additional Name(s) & Address(es) attached ☐ Yes ☒ No

3. Nature of conveyance:
☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other
Execution Date May 13, 2002

4. Application (number(s) or patent number(s):
If this document is being filed together with a new application, the execution date of the application is:

A. Patent Application No.(s)
U.S. Serial No. 10/107,495 filed March 27, 2002
Attorney Docket No. 09792909-5325

B: Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

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5. Name and address of party to whom correspondence concerning document should be mailed:

SONNENSCHEIN NATH & ROSENTHAL
P.O. Box #061080
Wacker Drive Station
Sears Tower
Chicago, IL 60606-1080
Customer ID No. 26263

6. Total number of applications and patents involved: 1

7. Total Fee (37 CFR 3.41 .... $ 40.00
☒ Enclosed
☒ Authorized to be charged to deposit account: any additional fees

8. Deposit Account Number:
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Statement and signature:
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

David R. Metzger	David R. Metzger	May 23, 2002
Name of Person Signing	Signature	Date

Total number of pages 3

Mail documents to be recorded and required cover sheet information to:
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ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in METHOD OF FABRICATING SEMICONDUCTOR DEVICE for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar ($1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 10/107,495, Filing Date: March 27, 2002.

This assignment executed on the dates indicated below.

SHUSAKU YANAGAWA

Name of first or sole inventor — Execution date of U.S. Patent Application

KANAGAWA, JAPAN

Residence of first or sole inventor

Shusaku Yanagawa — May 13, 2002

Signature of first or sole inventor — Date of this assignment

MASATSUGU IKEDA

Name of second inventor — Execution date of U.S. Patent Application

KAGOSHIMA, JAPAN

Residence of second inventor

Masatsugu Ikeda — May 13. 2002

Signature of second inventor — Date of this assignment

KENICHI KUBO

Name of third inventor — Execution date of U.S. Patent Application

KAGOSHIMA, JAPAN

Residence of third inventor

Kenichi . Kubo — May. 13 . 2002

Signature of third inventor — Date of this assignment

YOUICHI GOTO

Name of fourth inventor — Execution date of U.S. Patent Application

KAGOSHIMA, JAPAN

Residence of fourth inventor

Youichi Gotoh — May. 13. 2002

Signature of fourth inventor — Date of this assignment

Name of fifth inventor — Execution date of U.S. Patent Application

Residence of fifth inventor

Signature of fifth inventor — Date of this assignment